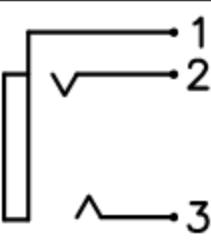
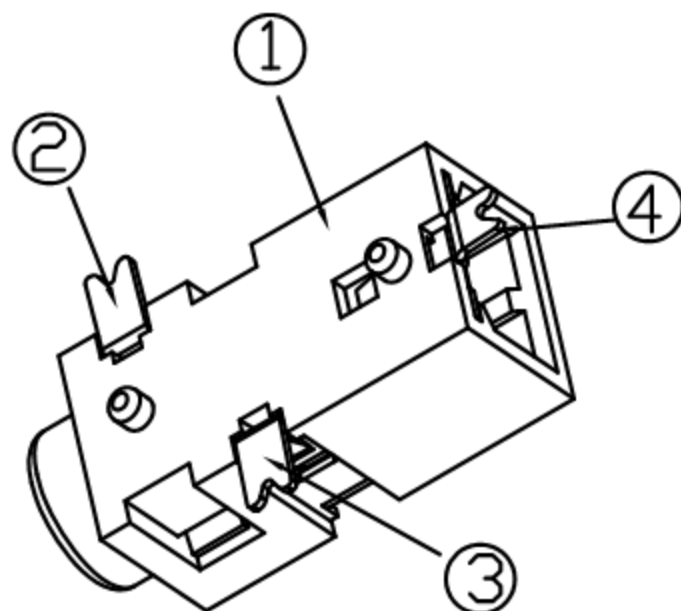
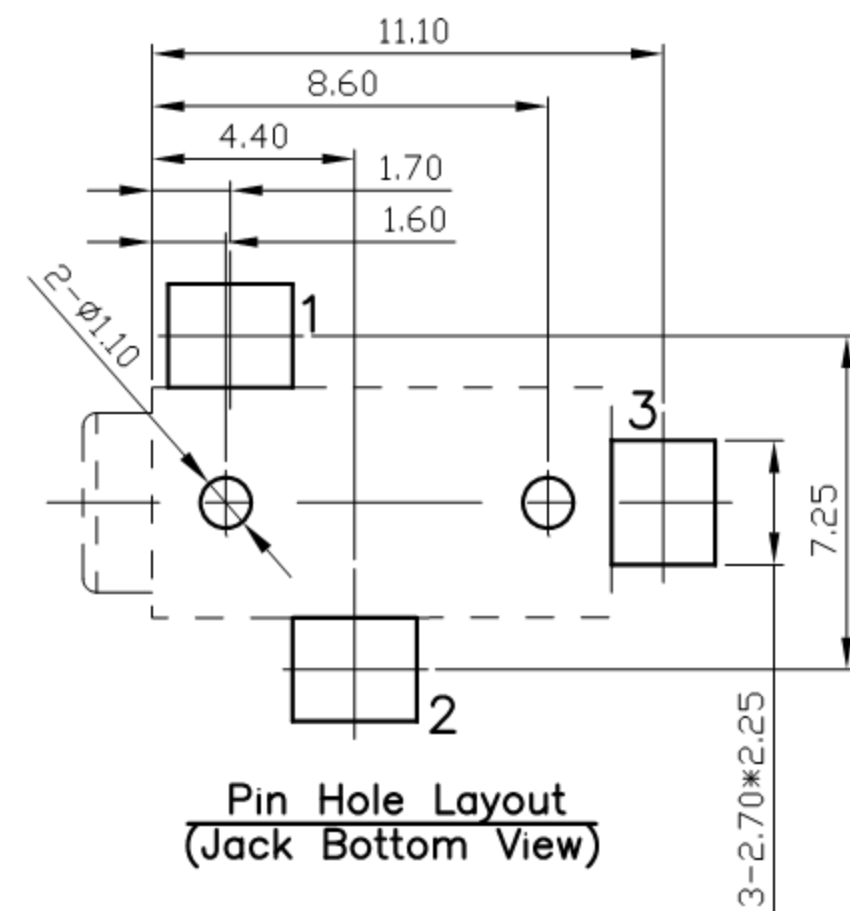
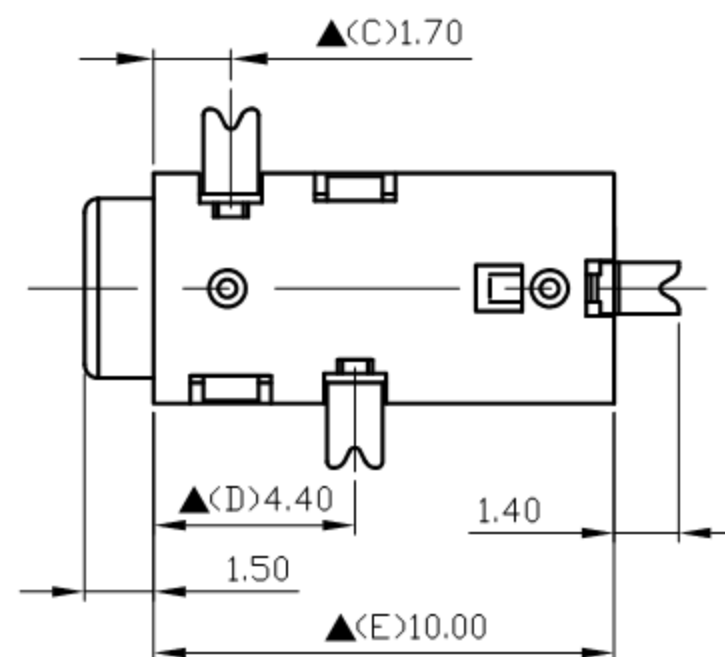
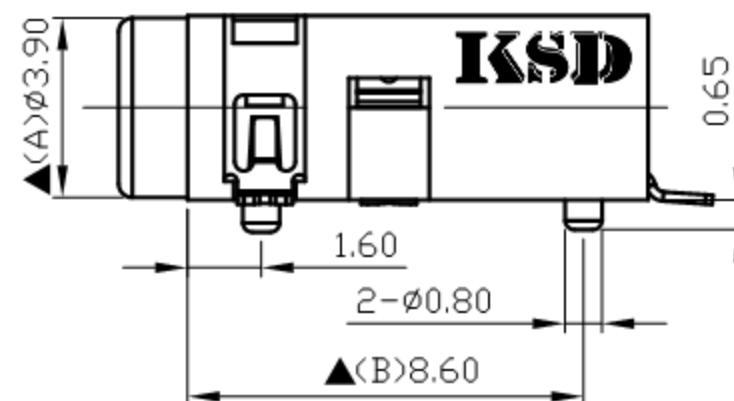
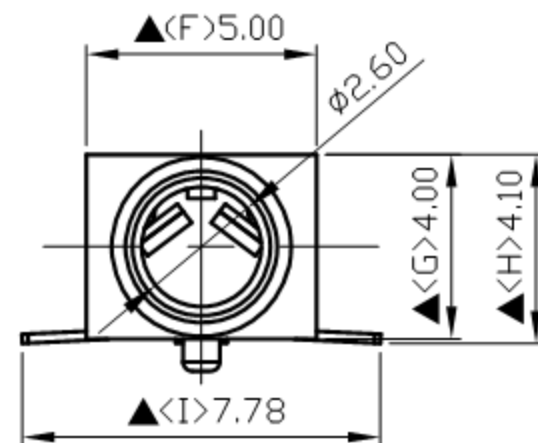


SCHEMATIC	
MODEL NO	X



4.	Tip Spring	0.2T	Phosphor Copper	1	Gold Plated
3.	Ring Spring	0.2T	Phosphor Copper	1	Gold Plated
2.	Earth Terminal	0.2T	Phosphor Copper	1	Gold Plated
1.	Housing	PA9T		1	Black Color
NO.	Description	Material		Q'TY	Finish



广东科斯达电子科技有限公司
GUANG DONG KE SI DA ELECTRONIC TECHNOLOGY CO., LTD.

DATE	DWN	CHKD	APVD	MANAGER
09.15.2021	王平華			

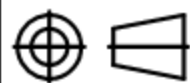
PART NAME : 2.5 ϕ PHONE JACK

PART NUMBER: SCJ234P00XG0B00G

VERSION: 7.0

TOLERANCE : $\pm 0.3\text{mm}$ UNLESS OTHERWISE SPECIFIED

UNIT: mm



SCALE: 1/1

SPECIFICATIONS:
Contact Resistance : 30m Ω max
Insulation Resistance : 100M Ω min. at DC 500V
Dielectric Withstanding Voltage: AC 500V for one minute
Remark: ▲: The Most Important Dimension

For Redference
僅供參考

RoHS&SVHC
Pb Free Process